

### NCE P-Channel Enhancement Mode Power MOSFET

#### **Description**

The NCE40P40K uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge .This device is well suited for high current load applications.

#### **General Features**

V<sub>DS</sub> =-40V,I<sub>D</sub> =-40A

 $R_{DS(ON)}$  <14m $\Omega$  @  $V_{GS}$ =-10V

 $R_{DS(ON)}$  <24m $\Omega$  @  $V_{GS}$ =-4.5V

- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E<sub>AS</sub>
- Excellent package for good heat dissipation

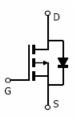
#### **Application**

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply



100% ΔVds TESTED!

Package Marking and Ordering Information



#### Schematic diagram



Marking and pin assignment



TO-252-2L top view

# Device Marking Device Device Package Reel Size Tape width Quantity NCE40P40K NCE40P40K TO-252-2L

Absolute Maximum Ratings (T<sub>C</sub>=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	-40	V
Gate-Source Voltage	V <sub>G</sub> S	±20	V
Drain Current-Continuous	I <sub>D</sub>	-40	А
Drain Current-Continuous(T <sub>C</sub> =100 °C)	I <sub>D</sub> (100℃)	-28	Α
Pulsed Drain Current	I <sub>DM</sub>	-160	Α
Maximum Power Dissipation T <sub>C</sub> =25°C	P <sub>D</sub>	80	W
Derating factor		0.53	W/℃
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	544	mJ
Drain Source voltage slope, V⊳s ≤-32 V,	dv/dt	50	V/ns
Reverse diode dv/dt, V <sub>DS</sub> ≤-32 V, I <sub>SD</sub> <i<sub>D</i<sub>	dv/dt	15	V/ns
Operating Junction and Storage Temperature Range	$T_{J}, T_{STG}$	-55 To 175	$^{\circ}$ C

# Thermal Characteristic

Thermal Resistance, Junction-to-Case(NOLE 2)	R <sub>eJC</sub>	1.88	°C/W
Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{\theta JA}$	50	°C/W



# Electrical Characteristics (T<sub>C</sub>=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =-250μA	-40	-	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-40V,V <sub>GS</sub> =0V	-	-	-1	μΑ
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =-250μA	-1.5	-1.9	-2.5	V
Danie Course On Otata Daniel	В	V <sub>GS</sub> =-10V, I <sub>D</sub> =-12A	-	12	14	mΩ
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-12A	-	18.5	24	mΩ
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =-5V,I <sub>D</sub> =-12A	-	34	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C <sub>lss</sub>	\/ - 20\/\/ -0\/	-	2960	-	PF
Output Capacitance	Coss	$V_{DS}$ =-20V, $V_{GS}$ =0V, F=1.0MHz	-	370	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>		-	310	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t <sub>d(on)</sub>		-	10	-	nS
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =-20V, $I_{D}$ =-12A $V_{GS}$ =-10V, $R_{G}$ =3 $\Omega$	-	18	-	nS
Turn-Off Delay Time	$t_{d(off)}$		-	38	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	24	-	nS
Total Gate Charge	Qg	V <sub>DS</sub> =-20,I <sub>D</sub> =-12A, V <sub>GS</sub> =-10V	-	42.2	72	nC
Gate-Source Charge	$Q_{gs}$		-	6.9		nC
Gate-Drain Charge	$Q_{gd}$		-	9.7		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	$V_{SD}$	V <sub>GS</sub> =0V,I <sub>S</sub> =-12A	-		-1.2	V
Diode Forward Current (Note 2)	Is		-	-	-40	Α
Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25°C, I <sub>F</sub> =- 12A	-	40		nS
Reverse Recovery Charge	Qrr	di/dt = -100A/µs <sup>(Note3)</sup>	-	42		nC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

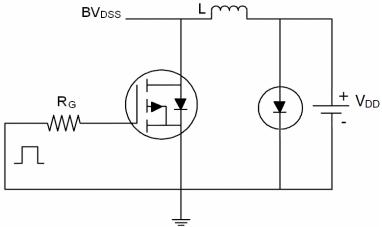
#### **Notes:**

- $\textbf{1.} \ \textbf{Repetitive Rating: Pulse width limited by maximum junction temperature.}$
- **2.** Surface Mounted on FR4 Board,  $t \le 10$  sec.
- 3. Pulse Test: Pulse Width  $\leq$  300 $\mu$ s, Duty Cycle  $\leq$  2%.
- 4. Guaranteed by design, not subject to production 5. E<sub>AS</sub> condition: Tj=25  $^{\circ}$ C,V<sub>DD</sub>=-20V,V<sub>G</sub>=-10V,L=1mH,Rg=25 $\Omega$

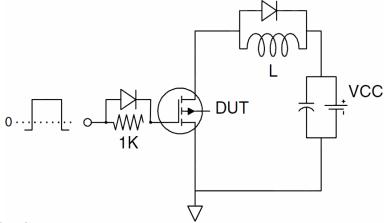


#### **Test Circuit**

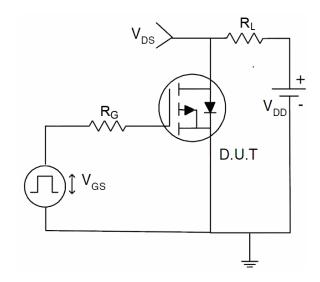
# 1) E<sub>AS</sub> Test Circuit



## 2) Gate Charge Test Circuit

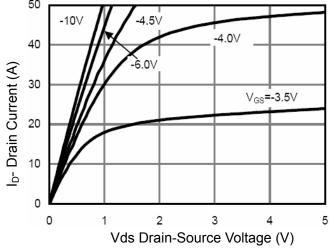


## 3) Switch Time Test Circuit

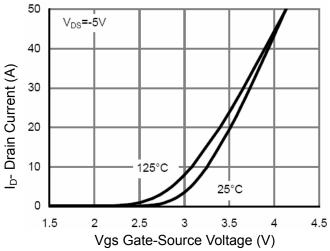




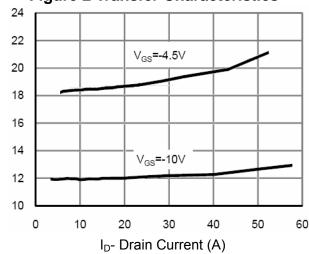




**Figure 1 Output Characteristics** 

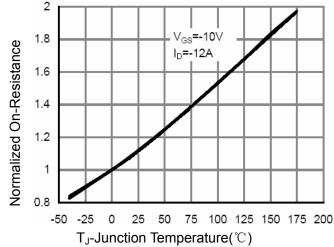


**Figure 2 Transfer Characteristics** 



Rdson On-Resistance(m 2)

Figure 3 Rdson- Drain Current



**Figure 4 Rdson-Junction Temperature** 

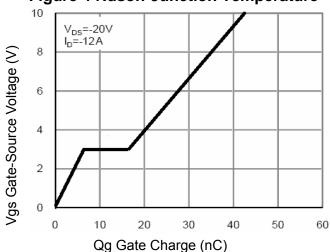


Figure 5 Gate Charge

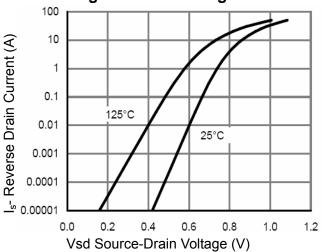


Figure 6 Source- Drain Diode Forward



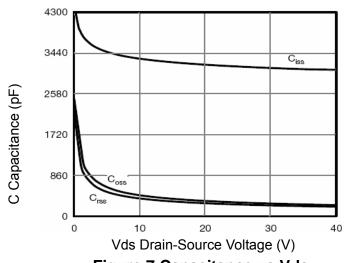


Figure 7 Capacitance vs Vds 1000 100 Ip- Drain Current (A) R<sub>DS(ON)</sub> limited 10 1ms 10ms 1 T<sub>J(Max)</sub>=175° C  $T_C=25^{\circ}$  C 0.1 0.1 10 100 Vds Drain-Source Voltage (V)

(norm) Ves=0
1.2
1.1
1.0
0.9
0.8
-50 0 50 100 T<sub>J</sub>(°C)
T<sub>J</sub>-Junction Temperature(°C)

 $\mathsf{BV}_{\mathsf{DSS}}$ 

Figure 9 BV<sub>DSS</sub> vs Junction Temperature 40 Ip- Drain Current (A) 30 20 10 0 0 25 50 75 100 125 150 175 T<sub>J</sub>-Junction Temperature(°C)

Figure 8 Safe Operation Area Figure 10 ID Current Derating vs Junction Temperature

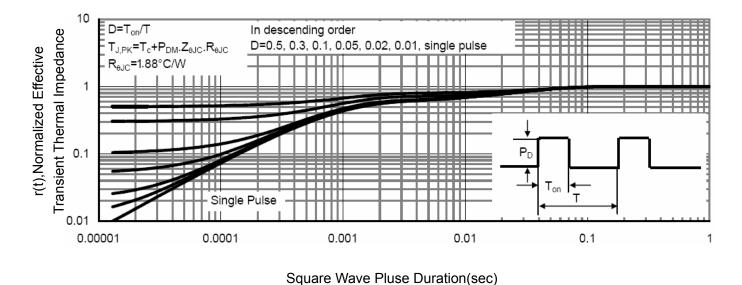
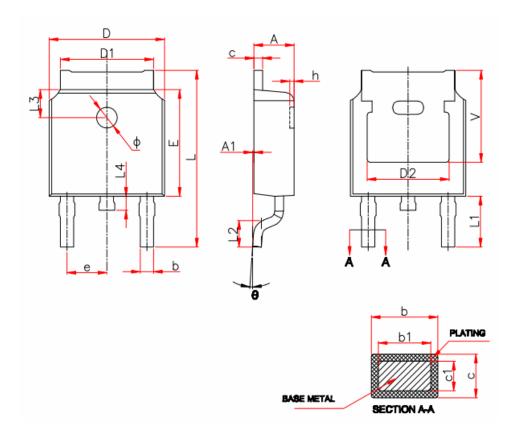


Figure 11 Normalized Maximum Transient Thermal Impedance



# **TO-252 Package Information**



Sumbol	Millin	meters	
Symbol	Min.	Max.	
Α	2.20	2.40	
A1	0.00	0.13	
b	0.66	0.86	
b1	0.73	0.79	
С	0.46	0.58	
c1	0.50	0.52	
D	6.50	6.70	
D1	5.10	5.46	
D2	4.83 REF.		
E	6.00	6.20	
е	2.19	2.39	
L	9.80	10.40	
L1	2.90 REF.		
L2	1.40	1.70	
L3	1.60 REF.		
L4	0.60	1.00	
Ф	1.10	1.30	
θ	0°	8°	

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